

## **Customer Presentation**

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#### High Performance PwrBlade® Connector - Overview

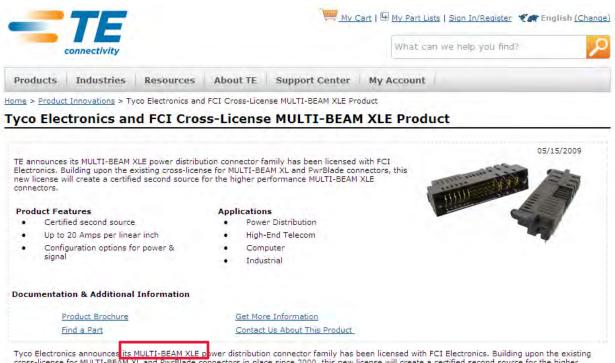
- Similar to PwrBlade but with an enhanced power contact design for increased linear current density
  - Includes a 48 A/contact high power option (8 contacts energized; 30 ° C T-rise in still air); represents an increase versus existing PwrBlade power contacts
  - Also includes a 27 A/contact lower power option (8 contacts energized; 30 ° C T-rise in still air); for multiple voltage applications with lower power but high density requirements
  - Both power contact options are hot-pluggable
- For next generation 1U and 2U pluggable power supplies with higher current density requirements
- Modular tooling design with capability for many combinations of high and low power contacts as well as signal contacts for power control
- High Power contacts of 5.08mm, 6.35mm, 7.62 and customised pitch is available upon request
- Half-bullet guide offers a smaller PCB needed size
- Licensed second-source agreement is already in place (see next slide)
- R/A header, R/A receptacle and vertical receptacle samples from production tooling are available at Q1 of 2012; vertical header samples are available in Q3 2012





#### **Product Development Background**

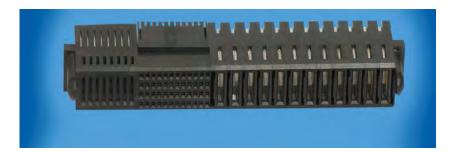
- Licensed from TF MBXLF
- TE and FCI target to be 2<sup>nd</sup> source to each other to secure the supply to worldwide end equipment manufacturers
- http://www.te.com/aboutus/news/prodinnov.aspx?id=1675

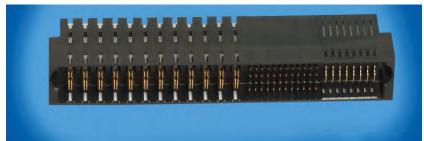


cross-license for MULTI-BEAM XL and PwrBlade connectors in place since 2000, this new license will create a certified second source for the higher performance MULTI-BEAM XLE connectors.

#### **Product Series**



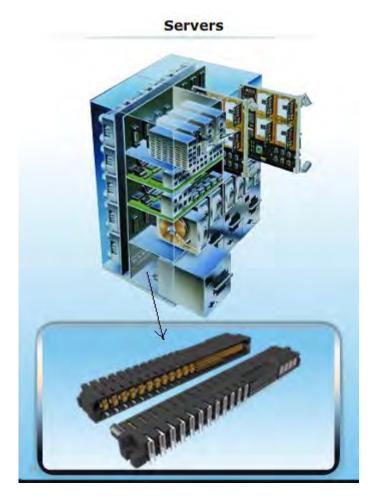




Droduoto DD .	Tail		Configurations	
Products PB+	roducts PB+ STB PF		Configurations	
R/A HDR	Yes	Yes	P+S+P, S+P, P+S, Only P, Only S	
R/A REC	Yes	Yes	P+S+P, S+P, P+S, Only P, Only S	
Vtl HDR	Yes	Yes	P+S+P, S+P, P+S, Only P, Only S	
Vtl Rec	Yes	Yes	P+S+P, S+P, P+S, Only P, Only S	

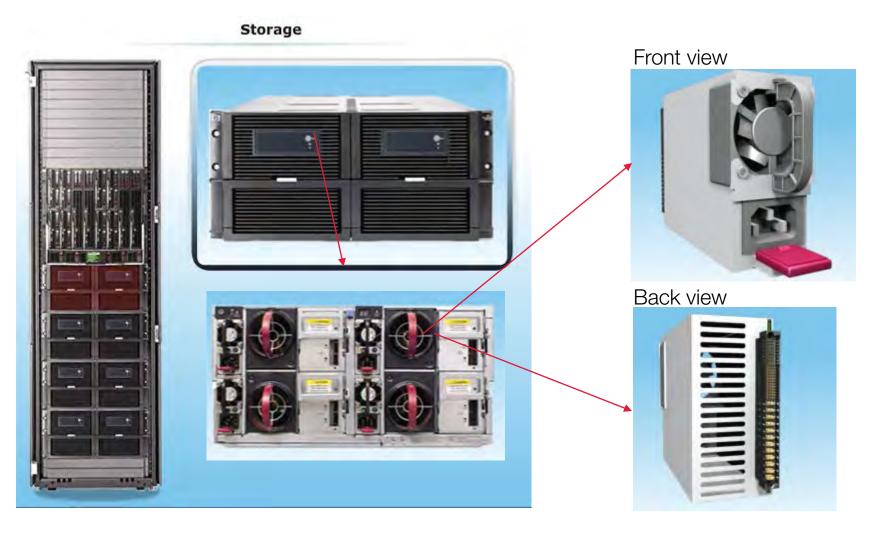
## **Product Application 1/3: Servers**





## **Product Application 2/3: Storage**





## **Product Application 3/3: Switches, Routers, Base Station**

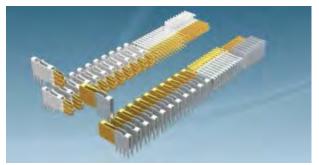




## **High Power Contacts**

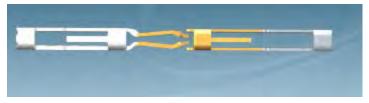










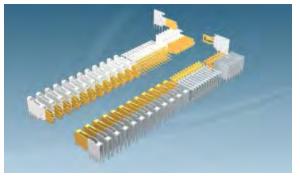




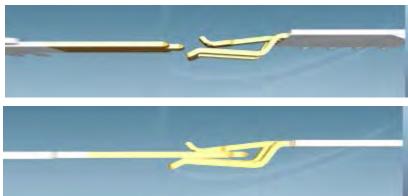
#### **Low Power Contacts**





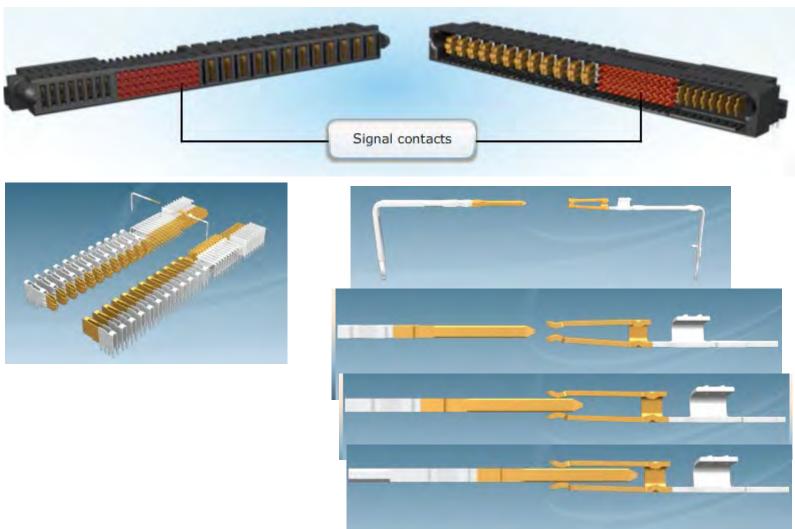






## **Signal Contacts**

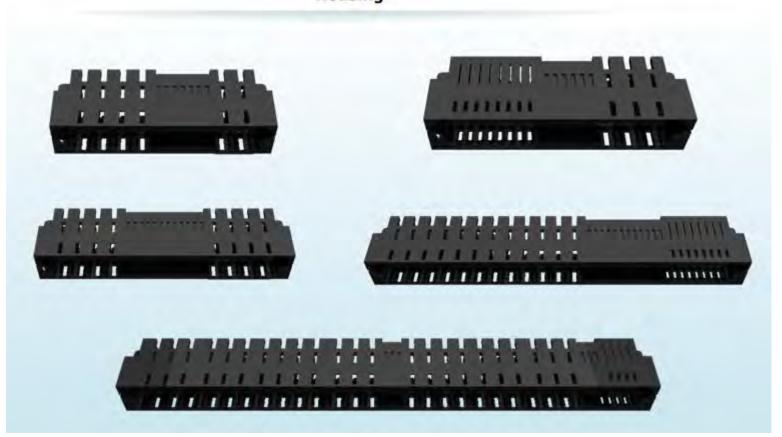




#### **Plastic Housing**

Full Modular design for Housing Tooling to meet various kinds of customer requirement for product configurations

#### Housing

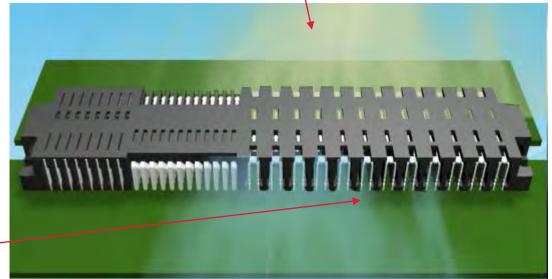


### Special Vent-designed HSG for better heat distribution





Heat distribution through and over the connectors

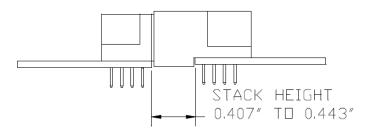


Heat distribution through and over the connectors

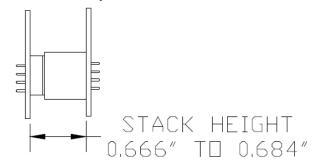
#### **Mating distance between PCB**



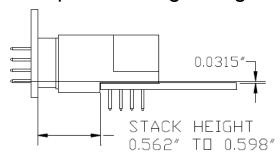
#### Right-Angle Receptacle to Right-Angle Header



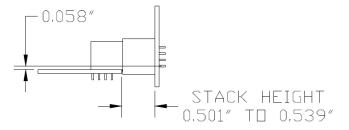
#### Vertical Receptacle to Vertical Header



#### Vertical Receptacle to Right-Angle Header



#### Right-Angle Receptacle to Vertical Header





#### **User PCB thickness guide**

FCI recommend connector users to follow the below table guide to choose PCB to have a good application and process.

	PC BOARD TH	IICKNESS		
	CONNECTOR WITH SOLDER TYPE CONTACTS			
CONNECTOR WITH PRESS-FIT CONTACTS	2.28 ± 0.40 TAIL LENGTH	3.43 ± 0.40 TAIL LENGTH	4.19±0.40 TAIL LENGTH	
1.35 [.053] Min	1.40~1.75 [.055~.069]	2.11~2.62 [.083~.103]	2.92~3.43[.115~.135]	

**User PCB Soldering** 

FCI recommend connector users to follow the below table guide to soldering connector onto PCB, by using Tin or Tin-lead solder material, PIP Process requires for Pwrblade Plus Special Part Number.to meet application request

SOLDERING PROCESS	WAVE TEMPERATURE	TIME (At Maximum Temperature)
Wave	265 ℃ [509°F]	10 Seconds

**Electrical Performance** 

Low Level Contact Resistance (LLCR) - The low level contact resistance shall not exceed

High Power contacts: 10 milliohm initially and 20 milliohm final

Low Power contacts: 15 milliohm initially and 20milliohm final

Signal contacts: 20milliohm final

after environmental exposure when measured in accordance with EIA-364-23 .The following details shall apply,

- Test Voltage 20 millivolts DC max open circuit volatge.
- Test Current Not to exceed 100 milliamps.

sLLCR at 3rd pa	CR at 3rd party joint qualification report			$m\Omega$ MAX.
		Spec	FCI/FCI	TE/TE
		10	0.3	0.4
		10	0.3	0.9
		10	0.3	0.4
Group 1	High Power	10	0.3	0.9
		10	0.4	0.4
Group 2	High Power	10	0.4	0.5
		10	0.5	1.8
Group 4	High Power	10	0.8	1.8
		10	0.3	0.4
		10	0.3	0.6
		10	0.4	0.9
		10	2.6	2.0
Group 5	High Power	10	1.8	2.3

#### Current rating

Note: Connectors are applied to test boards with 10 layers X 2 ounce copper power plane

Types	Pitch	Single	4 adjacent	8 adjacent	12 adjacent
	(mm)	Contact	Contacts	Contacts	Contacts
High Power Contact	7.62	75	67	N.A.	N.A.
High Power Contact	6.35	75	63	48	45
High Power Contact	5.08	75	58	45	43
Low Power Contact	2.92	49	28	27	N.A.

Right comparison chart

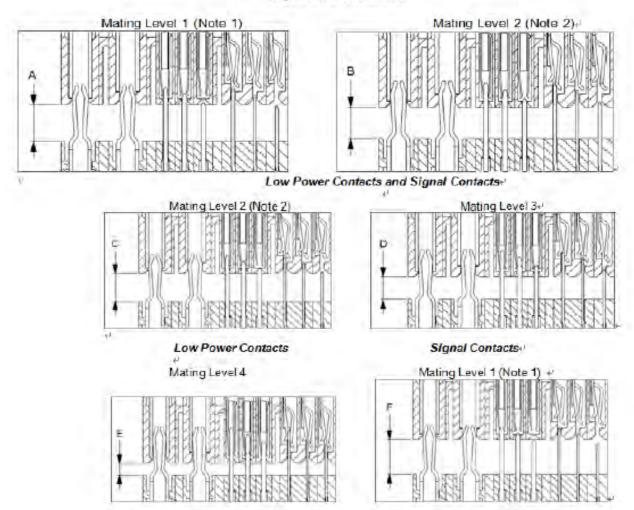
here showing how FCI's resistance is actually lower than TE's.

Types	Pitch	Single	24 adjacent	48 adjacent
	(mm)	Contact	Contacts	Contacts
Signal Contact	2.54	3	1.5	1

#### **Mating Sequences**



#### High Power Contacts



Note 1. The offset distance between "A" and "F" is not enough to consider these as separate levels + Note 2. The offset distance between "B" and "C" is not enough to consider these as separate levels ⊢

#### **Mechanical Performance**



Operating temp : -40 degree C -125 degree C

: 500cycles Durability

: Class-IIA, 14Days Duration MFG test

## PwrBlade® vs Pwr Blade+™

Pwr blade = TE MBXL Pwr blade Plus=TE MBXLE





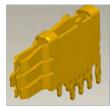


PB=Full Guide pin/post, PB+ is Half

Additional vent holes on PB+







High Power Pins, 3 beams

Low Power pins



#### PwrBlade® vs Pwr Blade+™



#### Pwr blade = TE MBXL Pwr blade Plus=TE MBXLE

#### Difference of PB and PB+

Items	PB+	PB
Mating cycles	500	200
Current Performance (30Degree C, still air, 8Ppins at 6.35mm)	48A	30A
End Module	Half	Full
Terminal thickness	PB+ TML thickness 40% more than PB	

#### Similarities of PB and PB+

Operating temperature: -40 to 125Degree C

Height above PCB

Stack Height

**HSG** width

Signal pin

Contact pitch same options

**LLCR** 

Contact Resistance

PCB hole size

#### **Material**



- The HSG made with glass filled high temp. nylon, UL94V-0
- The Terminal: High Conductivity Copper Alloy
- Hold Down: Copper Alloy
- Platg: Performance based platg for functional area, and SnPb or Sn over Ni for PCB interface

## Pwr Blade+™ and TE MBXLE 3<sup>rd</sup> party testing

#### **Test and Certificate**

- FCI Internal test: done and test report available upon request
- UL: E66906
- Joint test with TE MBXLE: Done, report available upon request
- RoHS compliance: Done, report available upon request
- Industry Stadadard: EIA-364

### **Product Key Documents**

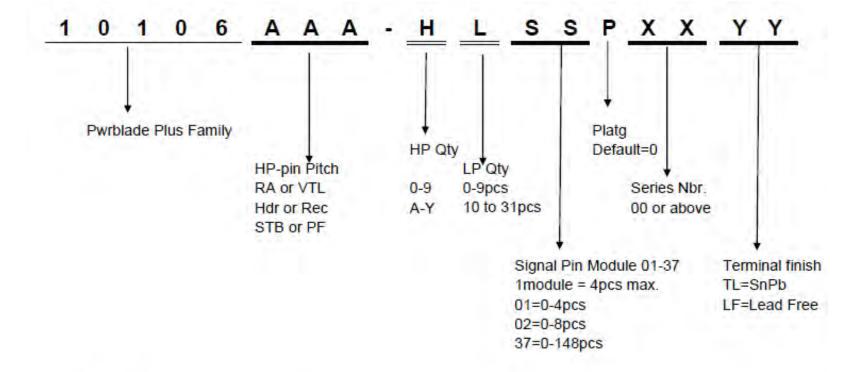
■ Prod Spec. : GS-12-658

■ Prod. Application : BUS-20-141



#### **Part Numbers**





Up to May, 2013

- 1) We have created PNs total 325
- 2) 160 out of 325 are already been approved by customer and becomes active in GPS for PO in
- 3) FCI is already been in first Inquiry-to position for about 40% inquiries from customers

#### **Part Numbers**



Bas
е
PN

101

06

AAA	High Power Contact Pitch	Right Angle/ Vertical	Header / Receptacle	Solder to Board/ Press F
116			Header	Solder To Board
117		Right Angle	neader	Press Fit
118		Right Angle	Receptacle	Solder To Board
119	7.50			Press Fit
120	7.62 mm		Mandar	Solder To Board
121		Vertical	Header	
122		vertical	Population	Solder To Board
123			Receptacle	Press Fit
124			0.000	Solder To Board
125		Dight Apple	Header	Press Fit
126	A	Right Angle	20040000	Solder To Board
127	P LEGICAL		Receptacle	Press Fit
128	6.35 mm		WEG301	Solder To Board
129	and the second s		Header	Press Fit
130		Vertical		Solder To Board
131			Receptacle	Press Fit
132				Solder To Board
133		m = 10 x 20 x 5x	Header	Press Flt
134		Right Angle		Solder To Board
135	100 Jan		Receptacle	Press Fit
136	5,08 mm		Header	Solder To Board
137		4.000000		Press Fit
138		Vertical	- 400 dog - 1	Solder To Board
139			Receptacle	Press Fit
262			WC0504	Solder To Board
263	A.	2000	Header	Press Fit
264		Right Angle	- 12	Solder To Board
265	Hybrid design or other		Receptacle	Press Fit
266	customized pitch		21/22/20	Solder To Board
267			Header	Press Fit
268		Vertical	V 7 - 1 - 1 - 2	Solder To Board
269			Receptacle	Press Fit





Power Blade + @ HPL 552	P/N and Drawing LT	Sample plant LT	Plant mass PO PELT	Quotation
PB RA HDR @ S&OP 5EEF				
PB RA Rec @ S&OP 5EFF	3 work days	4~5 wks, and target to meet	5 wks	2 work days
PB Vertical HDR @ S&OP 5EGF	5 WOIK days	2~3wks in the future	J WKS	2 WOIN days
PB Vertical Rec @ S&OP 5EHF				

Key contact name		
Technical Inquiry	AP - DON Pwrbld Plus Team	
Prod Manager	Daisy Liu	
Guardian Engineer	Fancy Zhang	
SCM Planner	Qin Liu	



# **THANK YOU**

